

Miniature Ceramic Fixed Attenuator

50Ω 1W 12dB DC to 7000 MHz

PAT-12+



Generic photo used for illustration purposes only

CASE STYLE: AF320

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Available Tape and Reel
at no extra cost

Reel Size Devices/Reel
7" 1000

Maximum Ratings

Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
Permanent damage may occur if any of these limits are exceeded.	

Pin Connections

INPUT	1
OUTPUT	3
GROUND	2,4

Features

- wideband, DC to 7000 MHz
- excellent VSWR, through entire band
- miniature size
- aqueous washable

Applications

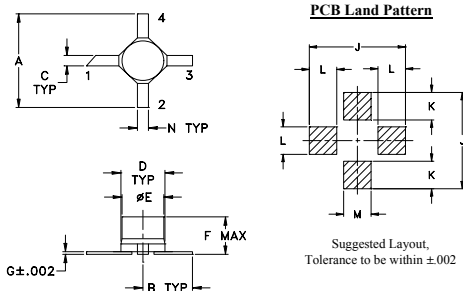
- power leveling
- impedance match improvement

Electrical Specifications at 25°C

FREQ. RANGE (MHz)	ATTENUATION (dB) Flatness, Max.			VSWR (:1) Max.			MAX. INPUT POWER (W)
	DC-1 GHz	DC-2.5 GHz	DC-f _u GHz	DC-1 GHz	DC-2.5 GHz	DC-f _u GHz	
DC-7000	12±0.6	0.5	0.6	1.8	1.3	1.4	1.5

1. RF power at 25°C case temperature: 1 Watt. Derate linearly to 0.1 Watt at 100°C.

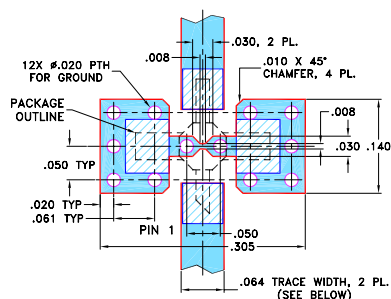
Outline Drawing



Outline Dimensions (inch/mm)

A	B	C	D	E	F	G
.200	.100	.020	.070	.068	.057	.005
5.08	2.54	0.51	1.78	1.73	1.45	0.13
H	J	K	L	M	N	wt
--	.230	.065	.060	.080	.040	grams
--	5.84	1.65	1.52	2.03	1.02	0.04

Demo Board MCL P/N: TB-319 Suggested PCB Layout (PL-208)



NOTES:

1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Notes

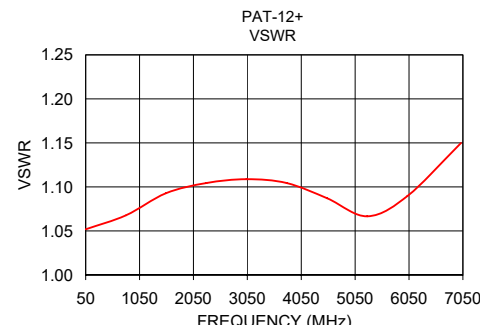
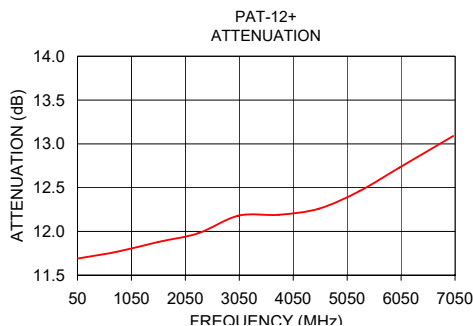
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Typical Performance Data

Frequency (MHz)	Attenuation (dB)	VSWR (:1)
50.00	11.69	1.05
796.25	11.77	1.07
1542.50	11.88	1.09
2288.75	11.98	1.10
3035.00	12.18	1.11
3781.25	12.19	1.10
4527.50	12.26	1.09
5273.75	12.46	1.07
6020.00	12.73	1.09
7015.00	13.09	1.15



REV. H
M151107
PAT-12+
200406

Typical Performance Data

FREQUENCY (MHz)	ATTENUATION (dB)	RETURN LOSS (dB)
50.00	11.69	31.95
796.25	11.77	29.70
1542.50	11.88	27.06
2288.75	11.98	26.09
3035.00	12.18	25.75
3781.25	12.19	26.09
4527.50	12.26	27.58
5273.75	12.46	29.83
6020.00	12.73	27.35
7015.00	13.09	23.13

REV. X1
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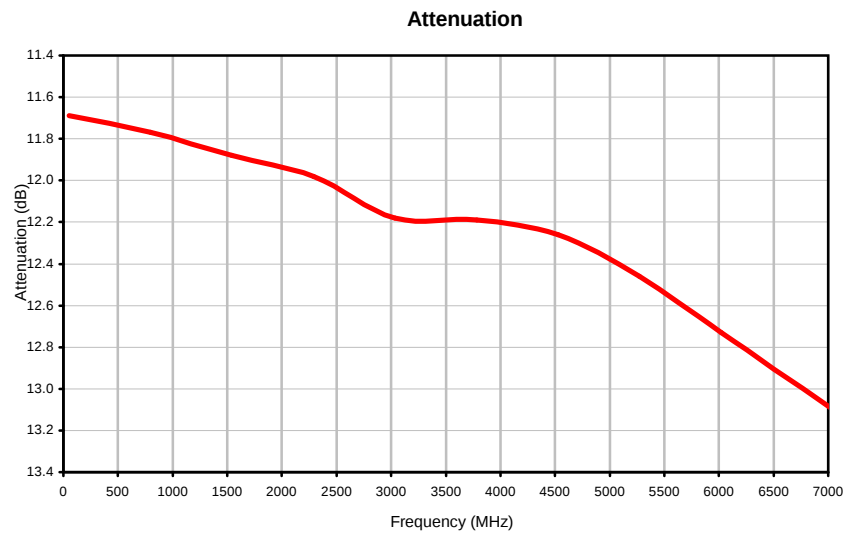
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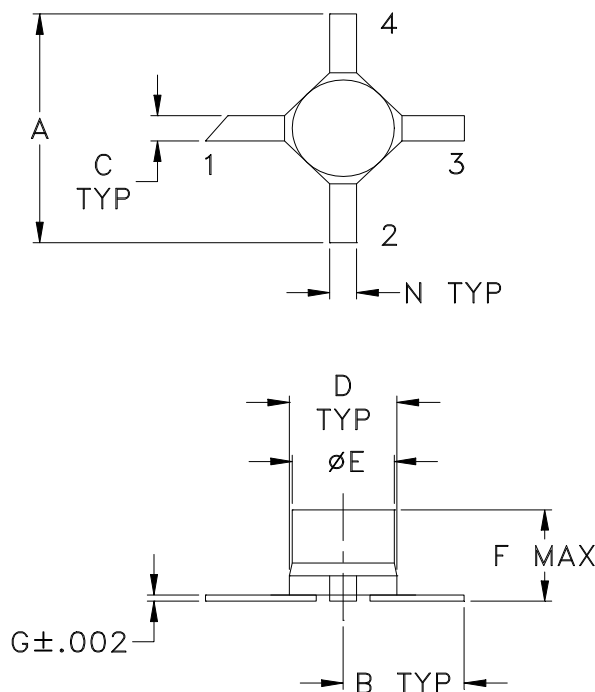
The Design Engineers Search Engine finds the model you need, Instantly • For detailed performance specs & shopping online see



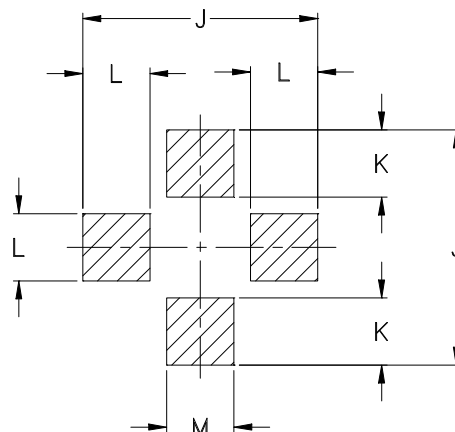
Typical Performance Curves



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	WT. GRAM
AF320	.200 (5.08)	.100 (2.54)	.020 (0.51)	.070 (1.78)	.068 (1.73)	.057 (1.45)	.005 (0.13)	-	.230 (5.84)	.065 (1.65)	.060 (1.52)	.080 (2.03)	.040 (1.02)	.04

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .03$; 3Pl. $\pm .015$

Notes:

- Case material: Ceramic.
- Termination material:
Nickel-Iron alloy 42.
- Termination finish:
For RoHS Case Styles: Tin-Silver alloy plate over Nickel barrier or Matte-Tin. (See Data Sheet)
For RoHS-5 Case Styles: Tin-Lead plate.
- Termination (1):
May have diagonal cut. Input and output interchangeable for PAT models only.
- Special Tolerances: Termination width $\pm .005$ inch, termination thickness $\pm .002$ inch, cap diameter $\pm .005$ inch.



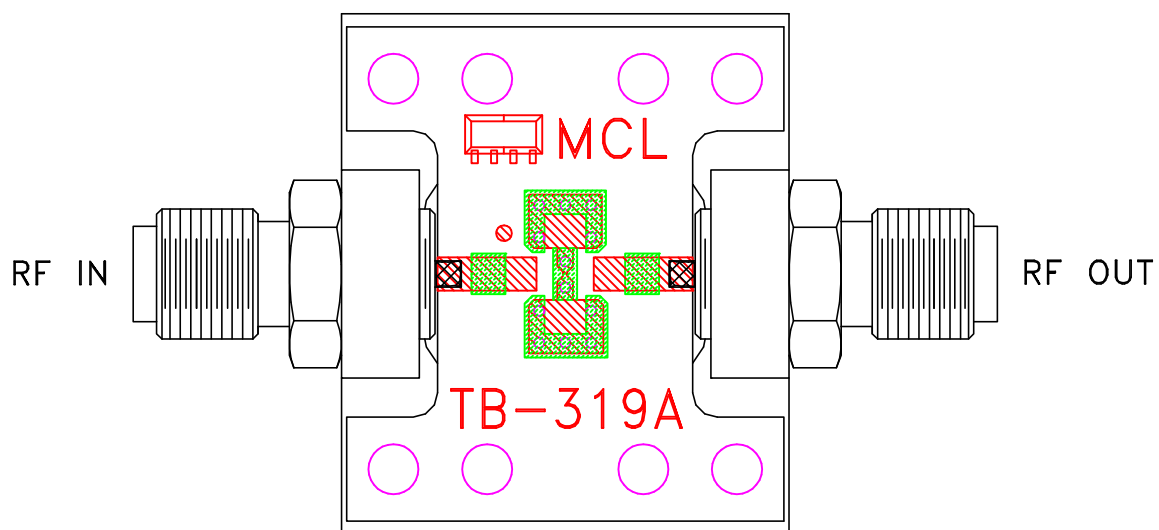
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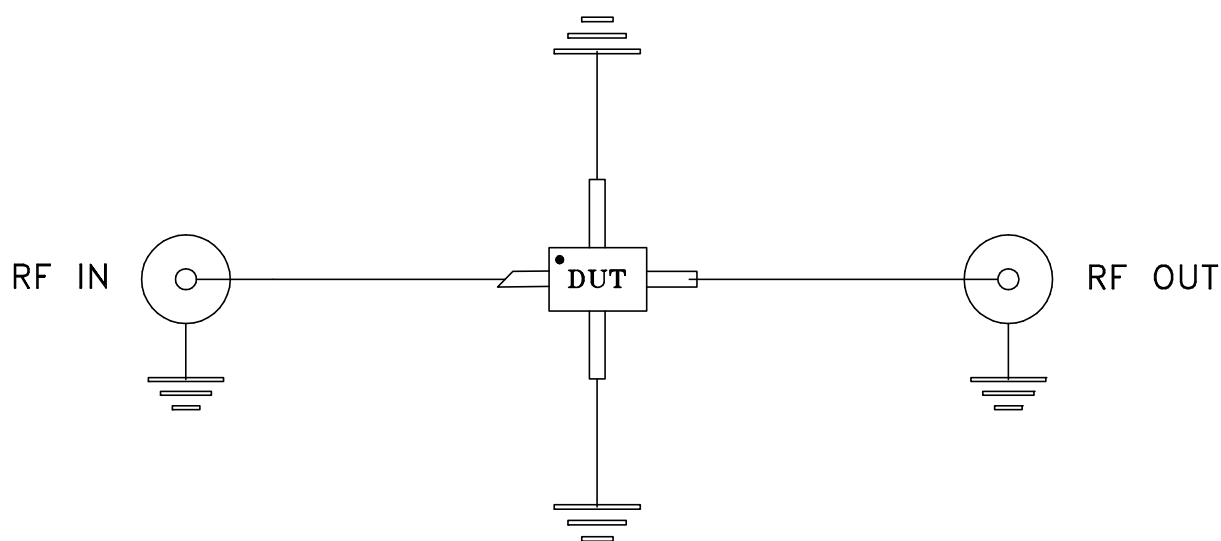
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Mini-Circuits ISO 9001 & ISO 14001 Certified

Evaluation Board and Circuit



TB-319



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-54° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-65° to 150° C Ambient Environment	Individual Model Data Sheet
Autoclave	15 psig, 100% RH, 121°C, 96 hours	JESD22-A102-C, Condition C
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Mechanical Shock	1.5Kg, 0.5 ms, 5 shock pulses, Y1 direction only	MIL-STD-883, Method 2002, Condition B, except Y1 direction only
Vibration (Variable Frequency)	50g peak	MIL-STD-883, Method 2007, Condition B
Constant Acceleration	Y1 plane only, 5 Kg	MIL-STD-883, Method 2001, Condition A, except Y1 plane only
Seal	Perfluorocarbon gross leak	MIL-STD-883, Method 1014, Condition C
HAST	130°C, 85% RH, 96 hours	JESD22-A110
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Solder Reflow Heat	Sn-Pb Eutetic Process: 240°C peak Pb-Free Process: 260°C peak	J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Moisture Sensitivity: Level 1	Bake at 125°C for 24 hours Soak at 85°C/85% RH for 168 hours, Reflow 3 cycles at 260°C peak	J-STD-020
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215